Infineon Technologies - MB90F387SPMCR-GS-N2E1 Datasheet

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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	F²MC-16LX
Core Size	16-Bit
Speed	16MHz
Connectivity	CANbus, SCI, UART/USART
Peripherals	POR, WDT
Number of I/O	36
Program Memory Size	64KB (64K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	2K x 8
Voltage - Supply (Vcc/Vdd)	3.5V ~ 5.5V
Data Converters	A/D 8x8/10b
Oscillator Type	External
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Surface Mount
Package / Case	48-LQFP
Supplier Device Package	48-LQFP (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/infineon-technologies/mb90f387spmcr-gs-n2e1

MB90387/387S/F387/F387S
MB90V495G

16-bit Microcontrollers
F²MC-16LX MB90385 Series

MB90385 series devices are general-purpose high-performance 16-bit micro controllers designed for process control of consumer products, which require high-speed real-time processing. The devices of this series have the built-in full-CAN interface.
The system, inheriting the architecture of F²MC family, employs additional instruction ready for high-level languages, expanded addressing mode, enhanced multiply-divide instructions, and enriched bit-processing instructions. Furthermore, employment of 32-bit accumulator achieves processing of long-word data (32 bits).
The peripheral resources of MB90385 series include the following:
8/10-bit A/D converter, UART (SCI), 8/16-bit PPG timer, 16-bit input-output timer (16-bit free-run timer, input capture 0, 1, 2, 3 (ICU)), and CAN controller.

Features

Clock

- Built-in PLL clock frequency multiplication circuit
- Selection of machine clocks (PLL clocks) is allowed among frequency division by two on oscillation clock, and multiplication of 1 to 4 times of oscillation clock (for 4-MHz oscillation clock, 4 MHz to 16 MHz).
- Operation by sub-clock (8.192 kHz) is allowed. (MB90387, MB90F387)
- Minimum execution time of instruction: 62.5 ns (when operating with 4-MHz oscillation clock, and 4-time multiplied PLL clock).

16 Mbyte CPU memory Space

- 24-bit internal addressing

Instruction System Best Suited to Controller

- Wide choice of data types (bit, byte, word, and long word)
- Wide choice of addressing modes (23 types)
- Enhanced multiply-divide instructions and RETI instructions
- Enhanced high-precision computing with 32-bit accumulator

Instruction System Compatible with High-level Language (C language) and Multitask

- Employing system stack pointer
- Enhanced various pointer indirect instructions
- Barrel shift instructions

Increased Processing Speed

- 4-byte instruction queue

Powerful Interrupt Function with 8 Levels and 34 Factors

Automatic Data Transfer Function Independent of CPU

- Expanded intelligent I/O service function (EI² OS): Maximum of 16 channels

Low Power Consumption (standby) Mode

- Sleep mode (a mode that halts CPU operating clock)
- Time-base timer mode (a mode that operates oscillation clock, sub clock, time-base timer and watch timer only)
- Watch mode (a mode that operates sub clock and watch timer only)
- Stop mode (a mode that stops oscillation clock and sub clock)
- CPU blocking operation mode

Process

- CMOS technology

I/O Port

- General-purpose input/output port (CMOS output):

  MB90387, MB90F387: 34 ports (including 4 high-current output ports)
  MB90387S, MB90F387S: 36 ports (including 4 high-current output ports)

Timer

- Time-base timer, watch timer, watchdog timer: 1 channel
- 8/16-bit PPG timer: 8-bit x 4 channels, or 16-bit x 2 channels
- 16-bit reload timer: 2 channels
- 16-bit input/output timer
  - ❒ 16-bit free run timer: 1 channel
  - ❒ 16-bit input capture: (ICU): 4 channels

  Interrupt request is issued upon latching a count value of 16-bit free run timer by detection of an edge on pin input.

CAN Controller: 1 channel

- Compliant with Ver2.0A and Ver2.0B CAN specifications
- 8 built-in message buffers
- Transmission rate of 10 kbps to 1 Mbps (by 16 MHz machine clock)
- CAN wake-up

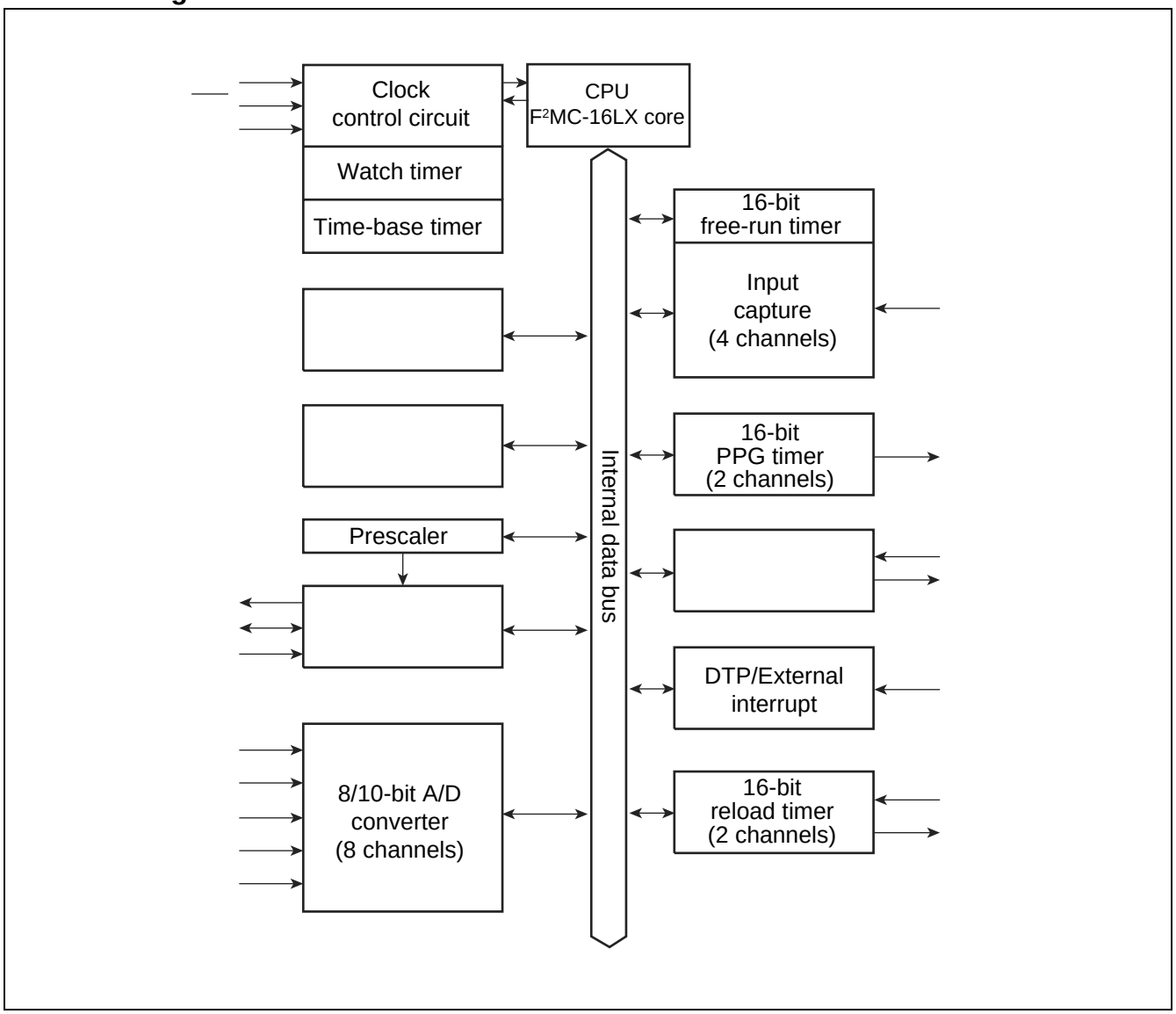
UART (SCI): 1 channel

- Equipped with full-duplex double buffer
- Clock-asynchronous or clock-synchronous serial transmission is available.

1. Product Lineup

Parameter \ Part Number		MB90F387 MB90F387S	MB90387 MB90387S	MB90V495G
Classification		Flash ROM	Mask ROM	Evaluation product
ROM capacity		64 Kbytes		–
RAM capacity		2 Kbytes		6 Kbytes
Process		CMOS		
Package		LQFP-48 (pin pitch 0.50 mm)		PGA-256
Operating power supply voltage		3.5 V to 5.5 V		4.5 V to 5.5 V
Special power supply for emulator*1		–		None
CPU functions		Number of basic instructions : 351 instructions Instruction bit length : 8 bits and 16 bits Instruction length : 1 byte to 7 bytes Data bit length : 1 bit, 8 bits, 16 bits		
		Minimum instruction execution time: 62.5 ns (at 16 MHz machine clock)		
		Interrupt processing time: 1.5 μs at minimum (at 16 MHz machine clock)		
Low power consumption (standby) mode		Sleep mode / Watch mode / Time-base timer mode / Stop mode / CPU intermittent		
I/O port		General-purpose input/output ports (CMOS output): 34 ports (36 ports*2) including 4 high-current output ports (P14 to P17)		
Time-base timer		18-bit free-run counter Interrupt cycle: 1.024 ms, 4.096 ms, 16.834 ms, 131.072 ms (with oscillation clock frequency at 4 MHz)		
Watchdog timer		Reset generation cycle: 3.58 ms, 14.33 ms, 57.23 ms, 458.75 ms (with oscillation clock frequency at 4 MHz)		
16-bit input/ output timer	16-bit free-run timer	Number of channels: 1 Interrupt upon occurrence of overflow		
	Input capture	Number of channels: 4 Retaining free-run timer value set by pin input (rising edge, falling edge, and both edges)		
16-bit reload timer		Number of channels: 2 16-bit reload timer operation Count clock cycle: 0.25 μs, 0.5 μs, 2.0 μs (at 16-MHz machine clock frequency) External event count is allowed.		
Watch timer		15-bit free-run counter Interrupt cycle: 31.25 ms, 62.5 ms, 12 ms, 250 ms, 500 ms, 1.0 s, 2.0 s (with 8.192 kHz sub clock)		
8/16-bit PPG timer		Number of channels: 2 (four 8-bit channels are available also.) PPG operation is allowed with four 8-bit channels or two 16-bit channels. Outputting pulse wave of arbitrary cycle or arbitrary duty is allowed. Count clock: 62.5 ns to 1 μs (with 16 MHz machine clock)		
Delay interrupt generator module		Interrupt generator module for task switching. Used for realtime OS.		
DTP/External interrupt		Number of inputs: 4 Activated by rising edge, falling edge, “H” level or “L” level input. External interrupt or expanded intelligent I/O service (EI^{2}OS) is available.		

8. Block Diagram



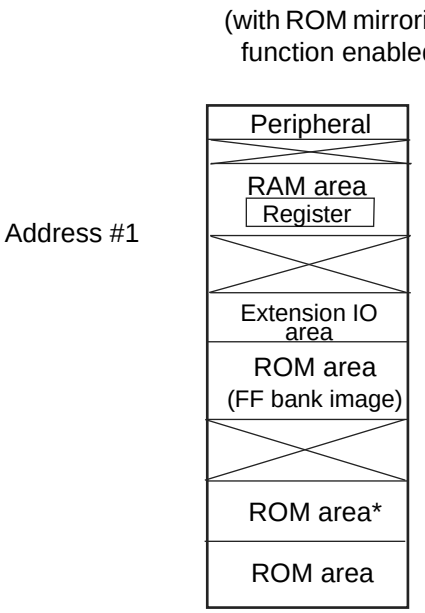
9. Memory Map

MB90385 series allows specifying a memory access mode “single chip mode.”

9.1 Memory Allocation of MB90385

MB90385 series model has 24-bit wide internal address bus and up to 24-bit bus of external address bus.
A maximum of 16-Mbyte memory space of external access memory is accessible.

9.2 Memory Map



Model	Address #1
	001900_H
	000900_H
	000900_H

: Internal access memory

: Access disallowed

*: On MB90387/S or MB90F387/S, to read "$FE0000_H$" to "$FEFFFF_H$" is to read out "$FF0000_H$" to "$FFFFFF_H$".

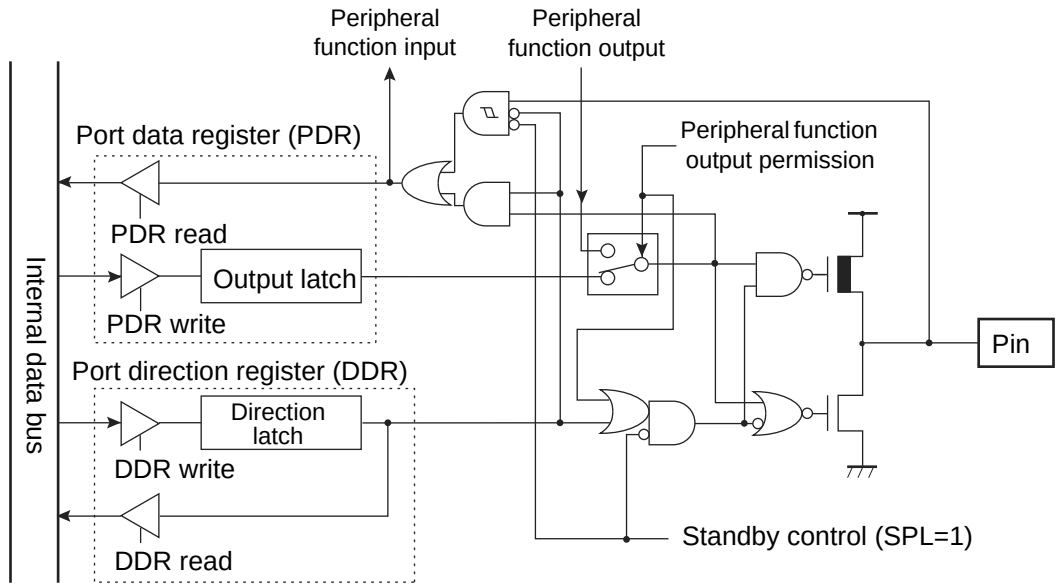
Note: When internal ROM is operating, F²MC-16LX allows viewing ROM data image on FF bank at upper-level of 00 bank. This function is called "mirroring ROM," which allows effective use of C compiler small model.
F²MC-16LX assigns the same low order 16-bit address to FF bank and 00 bank, which allows referencing table in ROM without specifying "far" using pointer.
For example, when accessing to "$00C000_H$", ROM data at "$FFC000_H$" is accessed actually. However, because ROM area of FF bank exceeds 48 Kbytes, viewing all areas is not possible on 00 bank image. Because ROM data of "$FF4000_H$" to "$FFFFFF_H$" is viewed on "004000_H" to "$00FFFF_H$" image, store a ROM data table in area "$FF4000_H$" to "$FFFFFF_H$."

Address	Register Abbreviation	Register	Read/ Write	Resource	Initial Value
000083H	(Reserved area) *				
000084H	TCANR	Send cancel register	W	CAN controller	00000000B
000085H	(Reserved area) *				
000086H	TCR	Send completion register	R/W	CAN controller	00000000B
000087H	(Reserved area) *				
000088H	RCR	Receive completion register	R/W	CAN controller	00000000B
000089H	(Reserved area) *				
00008AH	RRTRR	Receive RTR register	R/W	CAN controller	00000000B
00008BH	(Reserved area) *				
00008CH	ROVRR	Receive overrun register	R/W	CAN controller	00000000B
00008DH	(Reserved area) *				
00008EH	RIER	Receive completion interrupt permission register	R/W	CAN controller	00000000B
00008FH to 00009DH	(Reserved area) *				
00009EH	PACSR	Address detection control register	R/W	Address matching detection function	00000000B
00009FH	DIRR	Delay interrupt request generation/ release register	R/W	Delay interrupt generation module	XXXXXXX0B
0000A0H	LPMCR	Lower power consumption mode control register	W,R/W	Lower power consumption mode	00011000B
0000A1H	CKSCR	Clock selection register	R,R/W	Clock	11111100B
0000A2H to 0000A7H	(Reserved area) *				
0000A8H	WDTC	Watchdog timer control register	R,W	Watchdog timer	XXXXX111B
0000A9H	TBTC	Time-base timer control register	R/W,W	Time-base timer	1XX00100B
0000AAH	WTC	Watch timer control register	R,R/W	Watch timer	1X001000B
0000ABH to 0000ADH	(Reserved area) *				
0000AEH	FMCS	Flash memory control status register	R,W,R/W	512k-bit Flash memory	000X0000B
0000AFH	(Reserved area) *				

Address	Register Abbreviation	Register	Read/ Write	Resource	Initial Value
003910H	PRLL0	PPG0 reload register L	R/W	8/16-bit PPG timer	XXXXXXXXB
003911H	PRLH0	PPG0 reload register H	R/W		XXXXXXXXB
003912H	PRLL1	PPG1 reload register L	R/W		XXXXXXXXB
003913H	PRLH1	PPG1 reload register H	R/W		XXXXXXXXB
003914H	PRLL2	PPG2 reload register L	R/W		XXXXXXXXB
003915H	PRLH2	PPG2 reload register H	R/W		XXXXXXXXB
003916H	PRLL3	PPG3 reload register L	R/W		XXXXXXXXB
003917H	PRLH3	PPG3 reload register H	R/W		XXXXXXXXB
003918H to 00392FH	(Reserved area) *				
003930H to 003BFFH	(Reserved area) *				
003C00H to 003C0FH	RAM (General-purpose RAM)				
003C10H to 003C13H	IDR0	ID register 0	R/W	CAN controller	XXXXXXXXB to XXXXXXXXB
003C14H to 003C17H	IDR1	ID register 1	R/W		XXXXXXXXB to XXXXXXXXB
003C18H to 003C1BH	IDR2	ID register 2	R/W		XXXXXXXXB to XXXXXXXXB
003C1CH to 003C1FH	IDR3	ID register 3	R/W		XXXXXXXXB to XXXXXXXXB
003C20H to 003C23H	IDR4	ID register 4	R/W		XXXXXXXXB to XXXXXXXXB
003C24H to 003C27H	IDR5	ID register 5	R/W		XXXXXXXXB to XXXXXXXXB
003C28H to 003C2BH	IDR6	ID register 6	R/W		XXXXXXXXB to XXXXXXXXB
003C2CH to 003C2FH	IDR7	ID register 7	R/W		XXXXXXXXB to XXXXXXXXB
003C30H, 003C31H	DLCR0	DLC register 0	R/W		XXXXXXXXB, XXXXXXXXB
003C32H, 003C33H	DLCR1	DLC register 1	R/W		XXXXXXXXB, XXXXXXXXB
003C34H, 003C35H	DLCR2	DLC register 2	R/W		XXXXXXXXB, XXXXXXXXB
003C36H, 003C37H	DLCR3	DLC register 3	R/W		XXXXXXXXB, XXXXXXXXB

Address	Register Abbreviation	Register	Read/ Write	Resource	Initial Value
003C38H, 003C39H	DLCR4	DLC register 4	R/W	CAN controller	XXXXXXXXB, XXXXXXXXB
003C3AH, 003C3BH	DLCR5	DLC register 5	R/W		XXXXXXXXB, XXXXXXXXB
003C3CH, 003C3DH	DLCR6	DLC register 6	R/W		XXXXXXXXB, XXXXXXXXB
003C3EH, 003C3FH	DLCR7	DLC register 7	R/W		XXXXXXXXB, XXXXXXXXB
003C40H to 003C47H	DTR0	Data register 0	R/W		XXXXXXXXB to XXXXXXXXB
003C48H to 003C4FH	DTR1	Data register 1	R/W		XXXXXXXXB to XXXXXXXXB
003C50H to 003C57H	DTR2	Data register 2	R/W		XXXXXXXXB to XXXXXXXXB
003C58H to 003C5FH	DTR3	Data register 3	R/W		XXXXXXXXB to XXXXXXXXB
003C60H to 003C67H	DTR4	Data register 4	R/W		XXXXXXXXB to XXXXXXXXB
003C68H to 003C6FH	DTR5	Data register 5	R/W		XXXXXXXXB to XXXXXXXXB
003C70H to 003C77H	DTR6	Data register 6	R/W		XXXXXXXXB to XXXXXXXXB
003C78H to 003C7FH	DTR7	Data register 7	R/W		XXXXXXXXB to XXXXXXXXB
003C80H to 003CFFH	(Reserved area) *				
003D00H, 003D01H	CSR	Control status register	R/W, R	CAN controller	0XXXX001B, 00XXX000B
003D02H	LEIR	Last event display register	R/W		000XX000B
003D03H	(Reserved area) *				
003D04H, 003D05H	RTEC	Send/receive error counter	R	CAN controller	00000000B, 00000000B
003D06H, 003D07H	BTR	Bit timing register	R/W		11111111B, X1111111B
003D08H	IDER	IDE register	R/W		XXXXXXXXB
003D09H	(Reserved area) *				
003D0AH	TRTRR	Send RTR register	R/W	CAN controller	00000000B
003D0BH	(Reserved area) *				
003D0CH	RFWTR	Remote frame receive wait register	R/W	CAN controller	XXXXXXXXB

Port 4 Pins Block Diagram



Standby control: Control among Stop mode (SPL=1), Time-base timer mode (SPL=1), and watch mode (SPL=1).

Port 4 Registers

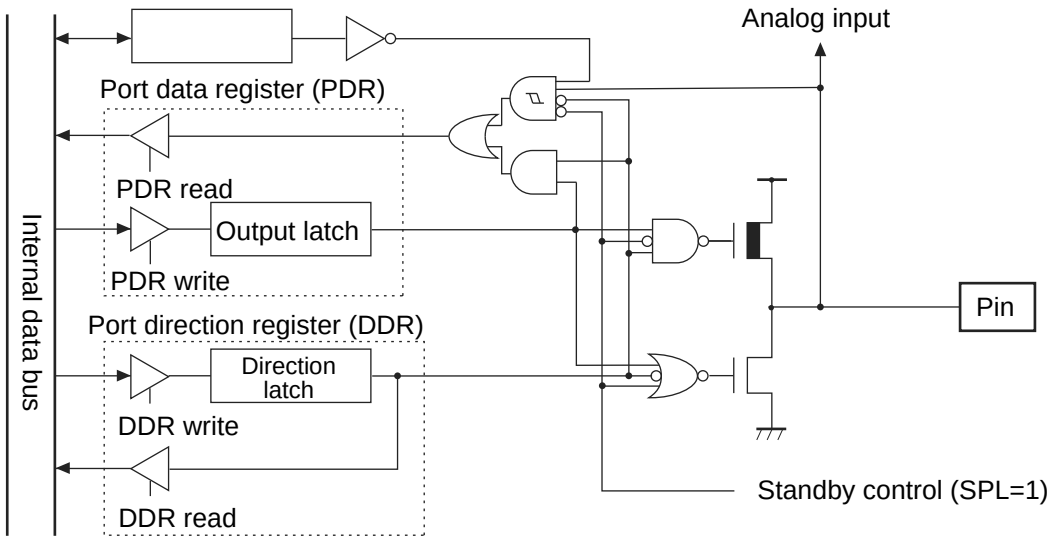
■ Port 4 registers include port 4 data register (PDR4) and port 4 direction register (DDR4).

■ The bits configuring the register correspond to port 4 pins on a one-to-one basis.

Relation between Port 4 Registers and Pins

Port Name	Bits of Register and Corresponding Pins									
Port 4	PDR4, DDR4	–	–	–	bit4	bit3	bit2	bit1	bit0
	Corresponding pins	–	–	–	P44	P43	P42	P41	P40

Port 5 Pins Block Diagram



Standby control: Control among Stop mode (SPL=1), Time-base timer mode (SPL=1), and watch mode (SPL=1).

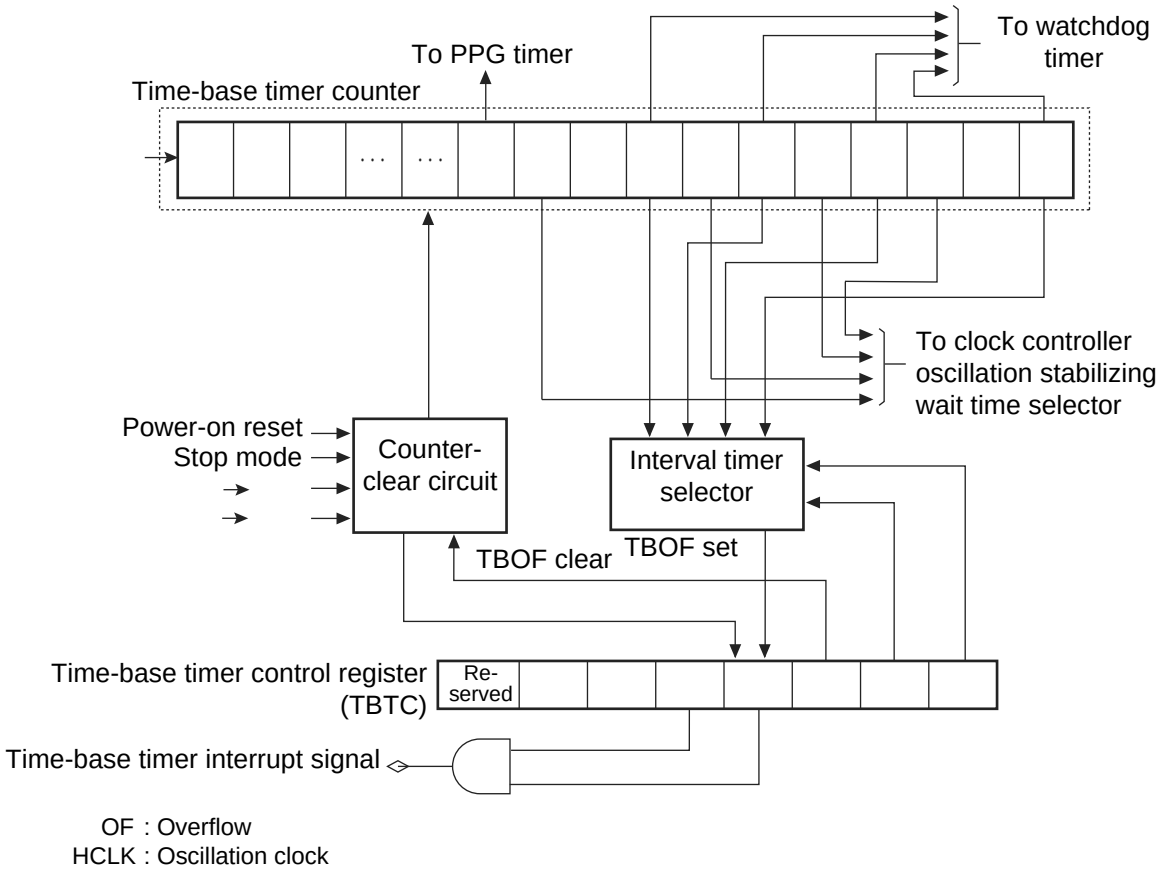
Port 5 Registers

- Port 5 registers include port 5 data register (PDR5), port 5 direction register (DDR5), and analog input permission register (ADER).
- Analog input permission register (ADER) allows or disallows input of analog signal to the analog input pin.
- The bits configuring the register correspond to port 5 pins on a one-to-one basis.

Relation between Port 5 Registers and Pins

Port Name	Bits of Register and Corresponding Pins								
Port 5	PDR5, DDR5	bit7	bit6	bit5	bit4	bit3	bit2	bit1	bit0
	ADER	ADE7	ADE6	ADE5	ADE4	ADE3	ADE2	ADE1	ADE0
	Corresponding pins	P57	P56	P55	P54	P53	P52	P51	P50

Time-base Timer Block Diagram



OF : Overflow
HCLK : Oscillation clock

*1: Switch machine clock from main clock to PLL clock.

*2: Switch machine clock from sub clock to main clock.

Actual interrupt request number of time-base timer is as follows:

Interrupt request number: #16 (10_H)

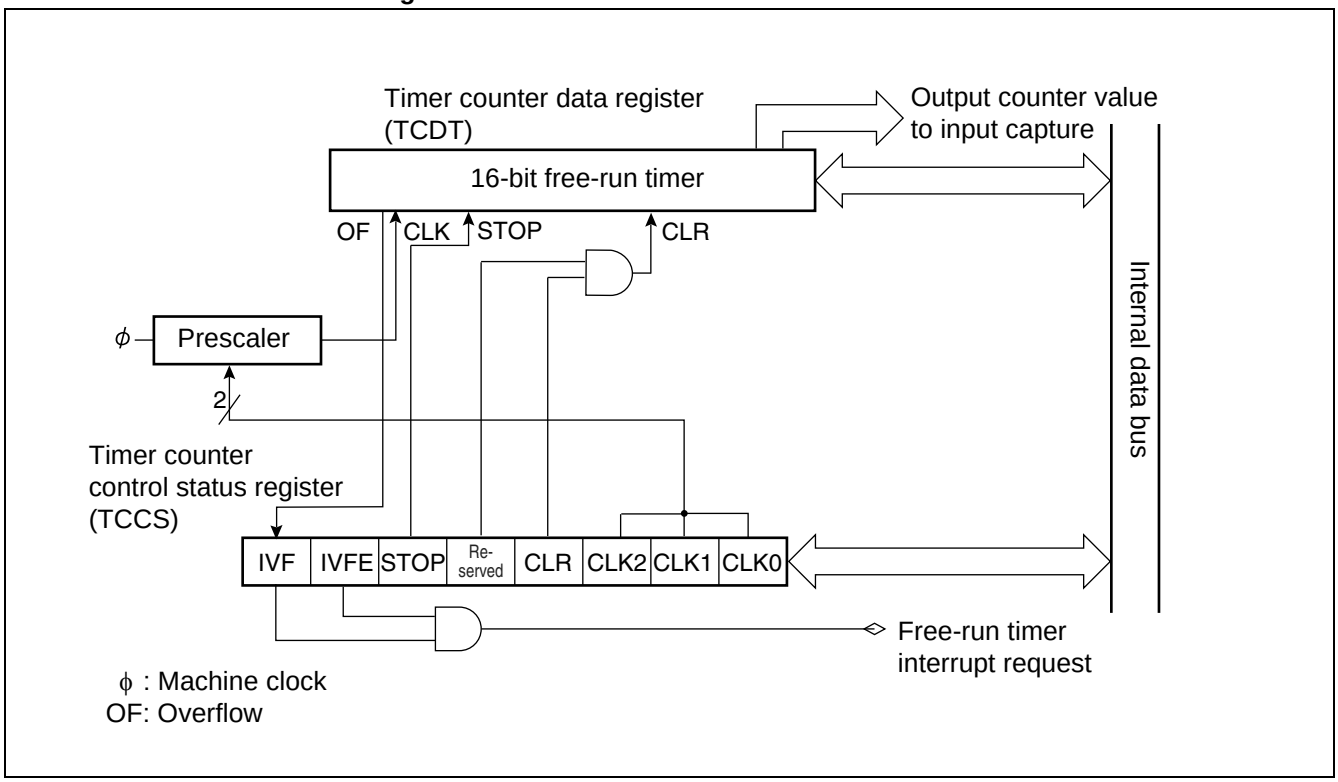
16-bit Free-run Timer

Counter value of 16-bit free-run timer is used as reference time (base time) of input capture.

Input Capture

Input capture detects rising edge, falling edge or both edges and retains a counter value of 16-bit free-run timer. Detection of edge on input signal is allowed to generate interrupt.

16-bit Free-run Timer Block Diagram



Detailed Pin Assignment on Block Diagram

The 16-bit input/output timer includes a 16-bit free-run timer. Interrupt request number of the 16-bit free-run timer is as follows:
Interrupt request number: 19 (13_H)

Prescaler

The prescaler divides a machine clock and provides a counter clock to the 16-bit up counter. Dividing ratio of the machine clock is specified by timer counter control status register (TCCS) among four values.

Timer Counter Data Register (TCDT)

The timer counter data register is a 16-bit up counter. A current counter value of the 16-bit free-run timer is read. Writing a value during halt of the counter allows setting an arbitrary counter value.

12.10 8/10-bit A/D Converter

The 8/10-bit A/D converter converts an analog input voltage into 8-bit or 10/bit digital value, using the RC-type successive approximation conversion method.

- Input signal is selected among 8 channels of analog input pins.
- Activation trigger is selected among software trigger, internal timer output, and external trigger.

Functions of 8/10-bit A/D Converter

The 8/10-bit A/D converter converts an analog voltage (input voltage) input to analog input pin into an 8-bit or 10-bit digital value (A/D conversion).

The 8/10-bit A/D converter has the following functions:

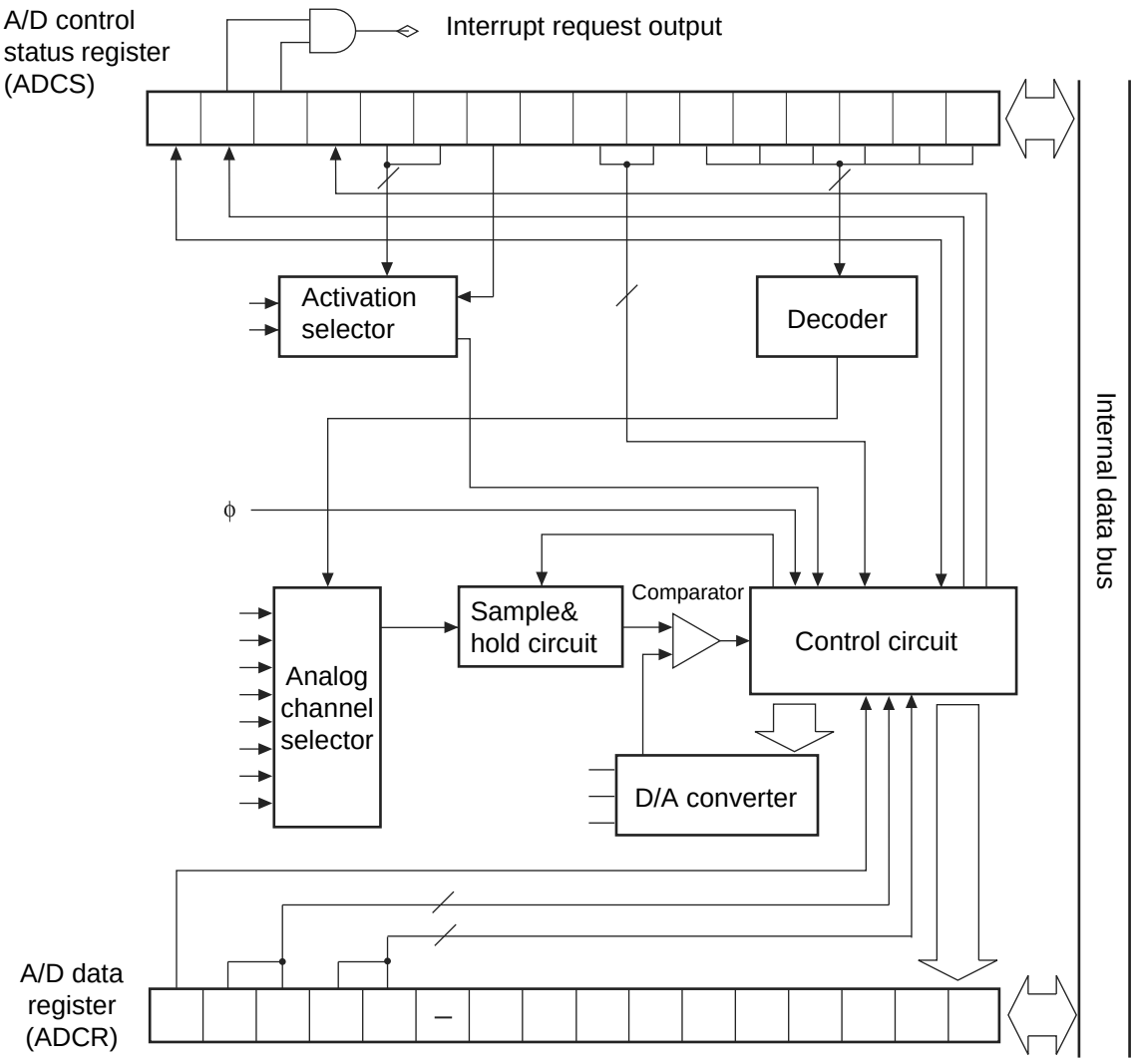
- A/D conversion takes a minimum of 6.12 μs* for 1 channel, including sampling time. (A/D conversion)
- Sampling of one channel takes a minimum of 2.0 μs*.
- RC-type successive approximation conversion method, with sample & hold circuit is used for conversion.
- Resolution of either 8 bits or 10 bits is specifiable.
- A maximum of 8 channels of analog input pins are allowed for use.
- Generation of interrupt request is allowed, by storing A/D conversion result in A/D data register.
- Activation of EI^{2}OS is allowed upon occurrence of an interrupt request. With use of EI^{2}OS, data loss is avoided even if A/D conversion is performed successively.
- An activation trigger is selectable among software trigger, internal timer output, and external trigger (fall edge).

: When operating with 16 MHz machine clock

8/10-bit A/D Converter Conversion Mode

Conversion Mode	Description
Singular conversion mode	The A/D conversion is performed form a start channel to an end channel sequentially. Upon completion of A/D conversion on an end channel, A/D conversion function stops.
Sequential conversion mode	The A/D conversion is performed form a start channel to an end channel sequentially. Upon completion of A/D conversion on an end channel, A/D conversion function resumes from the start channel.
Pausing conversion mode	The A/D conversion is performed by pausing at each channel. Upon completion of A/D conversion on an end channel, A/D conversion and pause functions resume from the start channel.

8/10-bit A/D Converter Block Diagram



TO : Internal timer output
– : Not defined
Reserved: Be sure to set to “0”
ϕ : Machine clock

12.12 CAN Controller

The Controller Area Network (CAN) is a serial communication protocol compliant with CANVer2.0A and Ver2.0B. The protocol allows data transmission and reception in both standard frame format and expanded frame format.

Features of CAN Controller

- CAN controller format is compliant with CANVer2.0A and Ver2.0B.
- The protocol allows data transmission and reception in standard frame format and expanded frame format.
- Automatic transmission of data frame by remote frame reception is allowed.
- Baud rate ranges from 10 kbps to 1 Mbps (with 16-MHz machine clock).

Table 12-5. Data Transmission Baud Rate

Machine Clock	Baud Rate (Max)
16 MHz	1 Mbps
12 MHz	1 Mbps
8 MHz	1 Mbps
4 MHz	500 kbps
2 MHz	250 kbps

- Provided with 8 transmission/reception message buffers.
- Transmission/reception is allowed at ID 11 bit in standard format, and at ID 29 bit in expanded frame format.
- Specifying 0 byte to 8 bytes is allowed in message data.
- Multi-level message buffer configuration is allowed.
- CAN controller has two built-in acceptance masks. Mask settings are independently allowed for the two acceptance masks on reception IDs.
- The two acceptance masks allow reception in standard frame format and expanded frame format.
- For types of masking, all-bit comparison, all-bit masking, and partial masking with acceptance mask register 0/1, are specifiable.

13. Electrical Characteristics

13.1 Absolute Maximum Rating

Parameter	Symbol	Rating		Unit	Remarks
		Min	Max		
Power supply voltage*1	V_{CC}	V_{SS} – 0.3	V_{SS} + 6.0	V	
	AV_{CC}	V_{SS} – 0.3	V_{SS} + 6.0	V	$V_{CC} = AV_{CC}$*2
	AVR	V_{SS} – 0.3	V_{SS} + 6.0	V	$AV_{CC} \geq AVR$*2
Input voltage*1	V_I	V_{SS} – 0.3	V_{SS} + 6.0	V	*3
Output voltage*1	V_O	V_{SS} – 0.3	V_{SS} + 6.0	V	*3
Maximum clamp current	I_{CLAMP}	– 2.0	+ 2.0	mA	*7
Total maximum clamp current	$\Sigma \mid I_{CLAMP} \mid$	–	20	mA	*7
“L” level maximum output current	I_{OL1}	–	15	mA	Normal output*4
	I_{OL2}	–	40	mA	High-current output*4
“L” level average output current	I_{OLAV1}	–	4	mA	Normal output*5
	I_{OLAV2}	–	30	mA	High-current output*5
“L” level maximum total output current	ΣI_{OL1}	–	125	mA	Normal output
	ΣI_{OL2}	–	160	mA	High-current output
“L” level average total output current	ΣI_{OLAV1}	–	40	mA	Normal output*6
	ΣI_{OLAV2}	–	40	mA	High-current output*6
“H” level maximum output current	I_{OH1}	–	–15	mA	Normal output*4
	I_{OH2}	–	–40	mA	High-current output*4
“H” level average output current	I_{OHAV1}	–	–4	mA	Normal output*5
	I_{OHAV2}	–	–30	mA	High-current output*5
“H” level maximum total output current	ΣI_{OH1}	–	–125	mA	Normal output
	ΣI_{OH2}	–	–160	mA	High-current output
“H” level average total output current	ΣI_{OHAV1}	–	–40	mA	Normal output*6
	ΣI_{OHAV2}	–	–40	mA	High-current output*6
Power consumption	P_D	–	245	mW	
Operating temperature	T_A	–40	+105	°C	
Storage temperature	Tstg	–55	+150	°C	

*1: The parameter is based on $V_{SS} = AV_{SS} = 0.0$ V.

*2: AVcc and AVR should not exceed Vcc.

*3: V_I and V_O should not exceed Vcc + 0.3 V. However if the maximum current to/from an input is limited by some means with external components, the I_{CLAMP} rating supersedes the V_I rating.

*4: A peak value of an applicable one pin is specified as a maximum output current.

*5: An average current value of an applicable one pin within 100 ms is specified as an average output current. (Average value is found by multiplying operating current by operating rate.)

*6: An average current value of all pins within 100 ms is specified as an average total output current. (Average value is found by multiplying operating current by operating rate.)

*7:

■ Applicable to pins: P10 to P17, P20 to P27, P30 to P33, P35*, P36*, P37, P40 to P44, P50 to P57
*: P35 and P36 are MB90387S and MB90F387S only.

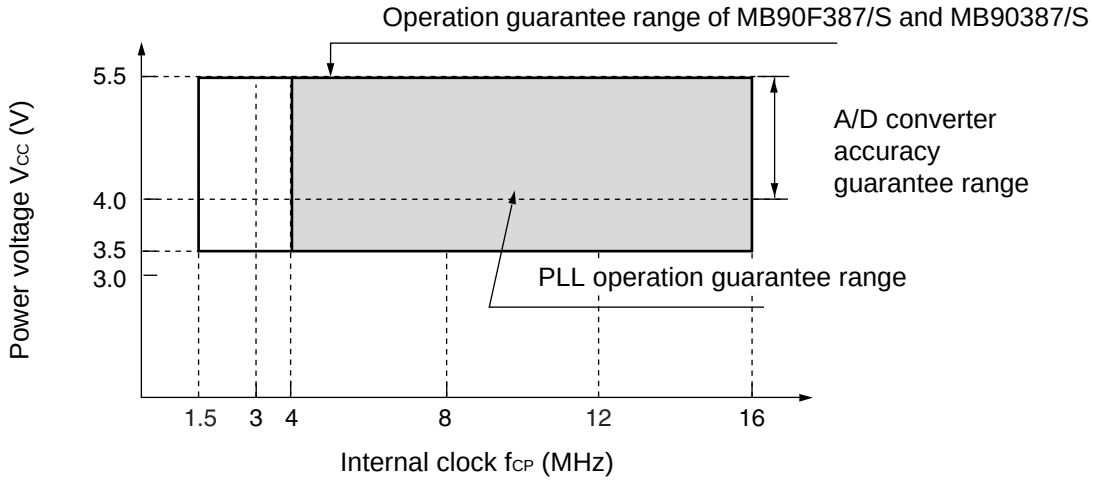
(V_{CC} = 5.0 V±10%, V_{SS} = AV_{SS} = 0.0 V, T_A = –40 °C to +105 °C)

Parameter	Symbol	Pin Name	Conditions	Value			Unit	Remarks
				Min	Typ	Max		
Power supply current*	I_{CCL}	V_{CC}	V_{CC} = 5.0 V, Internally operating at 8 kHz, subclock operation, T_A = + 25°C	—	0.3	1.2	mA	MB90F387/S
				—	40	100	µA	MB90387/S
	I_{CCLS}		V_{CC} = 5.0 V, Internally operating at 8 kHz, subclock, sleep mode, T_A = + 25°C	—	10	30	µA	
	I_{CCT}		V_{CC} = 5.0 V, Internally operating at 8 kHz, watch mode, T_A = + 25°C	—	8	25	µA	
	I_{CCH}		Stopping, T_A = + 25°C	—	5	20	µA	
Input capacity	C_{IN}	Other than AV_{CC}, AV_{SS}, AVR, C, V_{CC}, V_{SS}	–	—	5	15	pF	
Pull-up resistor	R_{UP}	RST	–	25	50	100	kΩ	
Pull-down resistor	R_{DOWN}	MD2	–	25	50	100	kΩ	Flash product is not provided with pull-down resistor.

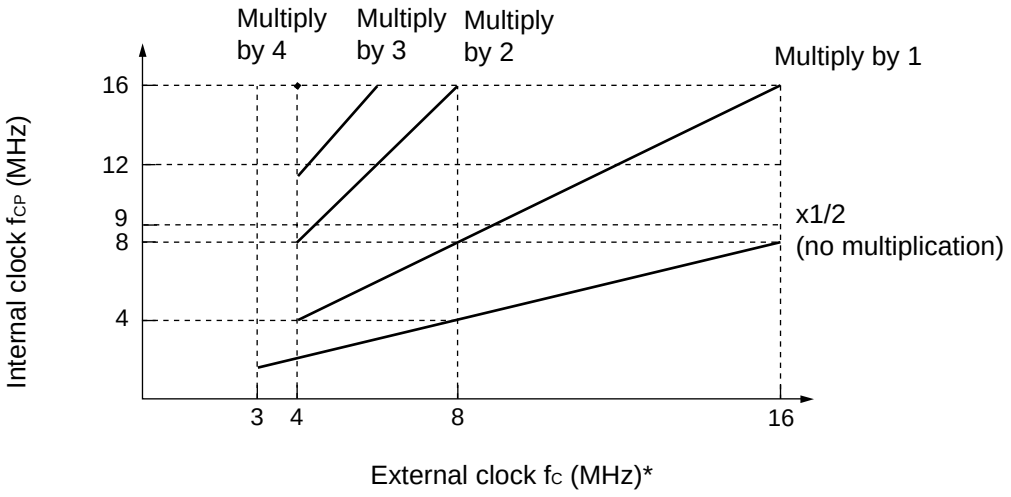
*: Test conditions of power supply current are based on a device using external clock.

• PLL operation guarantee range

Relation between internal operation clock frequency and power supply voltage



Relation among external clock frequency and internal clock frequency



*: fc is 8 MHz at maximum when crystal or ceramic resonator circuit is used.

13.4.4 UART Timing

(V_{CC} = 4.5 V to 5.5 V, V_{SS} = 0.0 V, T_A = −40 °C to +105 °C)

Parameter	Symbol	Pin Name	Conditions	Value		Unit	Remarks
				Min	Max		
Serial clock cycle time	t_{SCYC}	SCK1	Internal shift clock mode output pin is: CL = 80 pF+1TTL.	4 t_{CP} *	–	ns	
SCK ↓ → SOT delay time	t_{SLOV}	SCK1, SOT1		−80	+80	ns	
Valid SIN → SCK ↑	t_{IVSH}	SCK1, SIN1		100	–	ns	
SCK ↑ → valid SIN hold time	t_{SHIX}	SCK1, SIN1		60	–	ns	
Serial clock “H” pulse width	t_{SHSL}	SCK1	External shift clock mode output pin is: CL = 80 pF+1TTL.	2 t_{CP} *	–	ns	
Serial clock “L” pulse width	t_{SLSH}	SCK1		2 t_{CP} *	–	ns	
SCK ↓ → SOT delay time	t_{SLOV}	SCK1, SOT1		–	150	ns	
Valid SIN → SCK ↑	t_{IVSH}	SCK1, SIN1		60	–	ns	
SCK ↑ → valid SIN hold time	t_{SHIX}	SCK1, SIN1		60	–	ns	

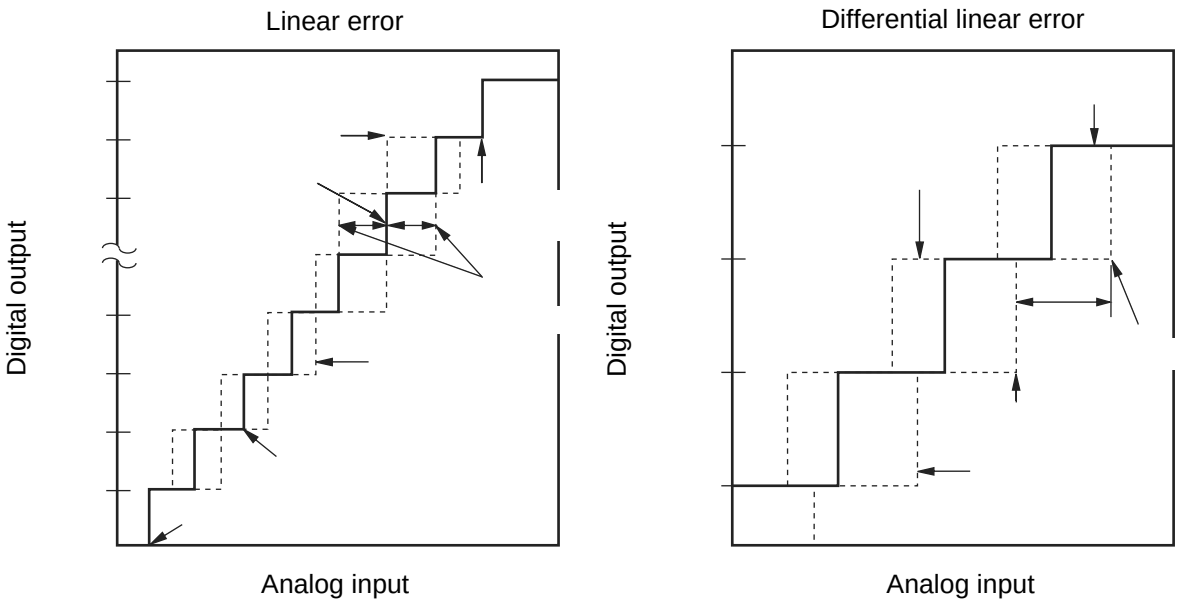
*: Refer to Clock Timing ratings for t_{CP} (internal operation clock cycle time).

Notes:

■ AC Characteristics in CLK synchronous mode.

■ C_L is a load capacitance value on pins for testing.

(Continued)



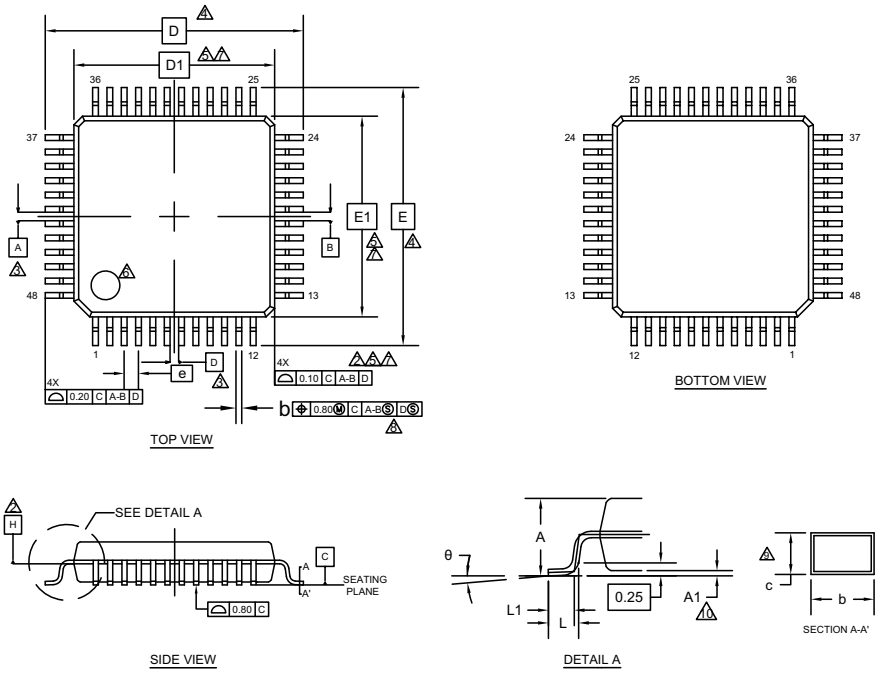
$$\text{Linear error of digital output N} = \frac{V_{NT} - \{1\ \text{LSB} \times (N - 1) + V_{OT}\}}{1\ \text{LSB}}\ [\text{LSB}]$$

$$\text{Differential linear error of digital output N} = \frac{V_{(N+1)T} - V_{NT}}{1\ \text{LSB}} - 1\text{LSB}\ [\text{LSB}]$$

$$1\ \text{LSB} = \frac{V_{FST} - V_{OT}}{1022}\ [\text{V}]$$

V_{OT}: Voltage at which digital output transits from “000_H” to “001_H.”
V_{FST}: Voltage at which digital output transits from “$3FE_H$” to “$3FF_H$.”

16. Package Dimension



SYMBOL	DIMENSIONS		
	MIN.	NOM.	MAX.
A	—	—	1.70
A1	0.00	—	0.20
b	0.15	—	0.27
c	0.09	—	0.20
D	9.00 BSC		
D1	7.00 BSC		
e	0.50 BSC		
E	9.00 BSC		
E1	7.00 BSC		
L	0.45	0.60	0.75
L1	0.30	0.50	0.70
θ	0°	—	8°

NOTES

1. ALL DIMENSIONS ARE IN MILLIMETERS.
2. DATUM PLANE H IS LOCATED AT THE BOTTOM OF THE MOLD PARTING LINE COINCIDENT WITH WHERE THE LEAD EXITS THE BODY.
3. DATUMS A-B AND D TO BE DETERMINED AT DATUM PLANE H.
4. TO BE DETERMINED AT SEATING PLANE C.
5. DIMENSIONS D1 AND E1 DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE PROTRUSION IS 0.25mm PRE SIDE. DIMENSIONS D1 AND E1 INCLUDE MOLD MISMATCH AND ARE DETERMINED AT DATUM PLANE H.
6. DETAILS OF PIN 1 IDENTIFIER ARE OPTIONAL BUT MUST BE LOCATED WITHIN THE ZONE INDICATED.
7. REGARDLESS OF THE RELATIVE SIZE OF THE UPPER AND LOWER BODY SECTIONS. DIMENSIONS D1 AND E1 ARE DETERMINED AT THE LARGEST FEATURE OF THE BODY EXCLUSIVE OF MOLD FLASH AND GATE BURRS. BUT INCLUDING ANY MISMATCH BETWEEN THE UPPER AND LOWER SECTIONS OF THE MOLDER BODY.
8. DIMENSION b DOES NOT INCLUDE DAMBER PROTRUSION. THE DAMBAR PROTRUSION (S) SHALL NOT CAUSE THE LEAD WIDTH TO EXCEED b MAXIMUM BY MORE THAN 0.08mm. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE LEAD FOOT.
9. THESE DIMENSIONS APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.10mm AND 0.25mm FROM THE LEAD TIP.
10. A1 IS DEFINED AS THE DISTANCE FROM THE SEATING PLANE TO THE LOWEST POINT OF THE PACKAGE BODY.

002-13731 **

PACKAGE OUTLINE, 48 LEAD LQFP
7.0X7.0X1.7 MM LQA048 REV**